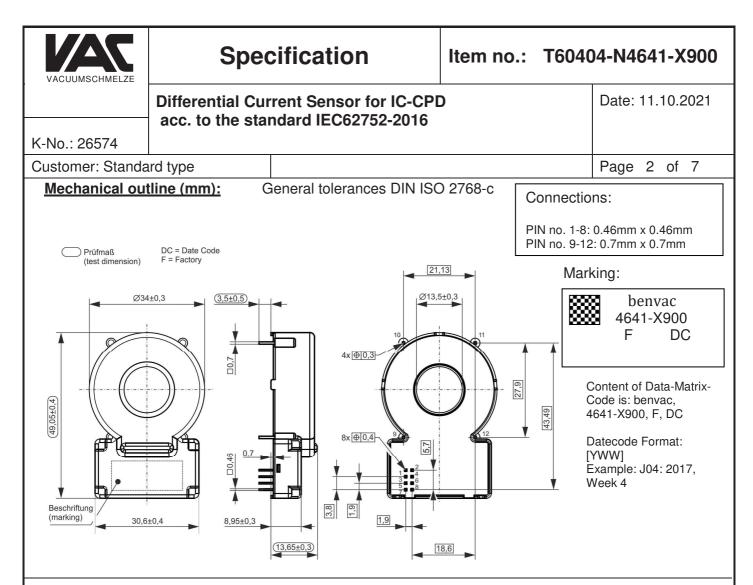
VACUUMSCHMEL	ZE	Spe	ecifica	tion	Item	Item no.: T60404-N4641-X900					
	0			ensor for IC-CF EC62752-2016	_		Date: 11	.10.2021			
K-No.: 26574											
Customer: Sta	ndard	l type					Page 1	ot 7			
 Description Fluxgate curre toroidal core PCB mounting 	g	sor with • E • A • S • (Switching ope Compact desi	uracy ed components en-collector outputs gn		Ma	plications inly used for stat bile applications: IC-CPD Wallbox				
		US9397494 / CN	103001175 //	EP2813856		4		11			
Electrical da			5140		min.	typ.	max.	Unit			
IP		•		nt (1phase / 3phas	se)	0	80 / 40	A			
IΔN1		Rated residual o				6		mA DC			
I _{ΔN2}		Rated residual o Frip tolerance 1	perating cur	rent 2	4	30 5	6	mA rms mA DC			
$\Delta N1$, tolerance		Frip tolerance 2			20	5	30 ⁽¹⁾ / 60 ⁽²⁾	mA rms			
IΔN2, tolerance SPWM-OUT	S	Scaling factor of for monitoring			20	3.33	30(7700(7	%/mA			
I _{ARI,1/2} (Fig.1)	F	Recovery curren	t level for I			2.5 / 10		mA			
·, // (* ·g· · /)	()	absolute value [JC/rms)				DC to 1kHz (2) f = 1				
Acourcov	Duna	mia parforma	naa data			(1) 1 = 1	JC [0] IKHZ (2) I = I				
		mic performa Max. measuring			-300		+300	mA			
I _{ΔN,max} X		Resolution (@		,	-300	< 0.2	+300	mA			
t _r (Fig.3)		Response time		0)			g to IEC62752:201				
f _{BW} (Fig.4)		Frequency rang			DC	7100010111	2	kHz			
General dat			<i></i>		20		_				
ϑ _A	_	Ambient operat	ion tempera	turo	-40		85	°C			
9 Storage		Ambient storag			-40		85	°C			
m		Mass	e temperate		-10	21	00	g			
V _{CC}		Supply voltage			4.8	5	5.2	V			
Icc		Consumption c	urrent		38	Ŭ	45	mA			
Sclear, ps		Clearance (prin		ndarv)		not applicable if	isolated cable is u				
Screep, ps		Creepage (prim					isolated cable is u				
FIT		EN/IEC 61709		• /		1529					
FII		(MIL-HDBK-217	7F) ⁽⁶⁾			(6349))	fit			
 (4) see VAC M-sh (5) Constructed, r Isolated wires Reinforced ins (6) The results are Environment of 	eet 3101 manufact are pref sulation, e valid un conditior	Insulation material g nder following condit n: ground mobile, no	e inside cardbo ccordance with hary conductors roup 1, Pollutio tions: 55°C mea dust or harmful	ard packaging	00m and oververmemperature by c	oltage category l continuous opera	ation (8760h per yea				
The Sensor i applications. fault current, current fault,	is sens The S PIN 3 PINs 3	Sensor detects A will change it's 3 and 4 will cha	DC current C and DC f state from a nge state fro	and can be used f ault currents accor low level (GND) t om a low level (GN naled on PIN 1 (EF	rding to IEC to high impe ID) to a hig	62752:2016 edance level h impedance	. In the event o . In event of an				
Datum Name	Index	Änderung									
11.10.2021 BZ	-	Patents added on s									
23.01.20 BZ		1	and Screep, p	p (Clearance, unisolate	ed primary to	primary) deleted					
Editor.: R&D-PD-I	VPI D	Designer: MB		MC-PM: BZ			Release	d by: SB			

Designer: MB



PIN description:

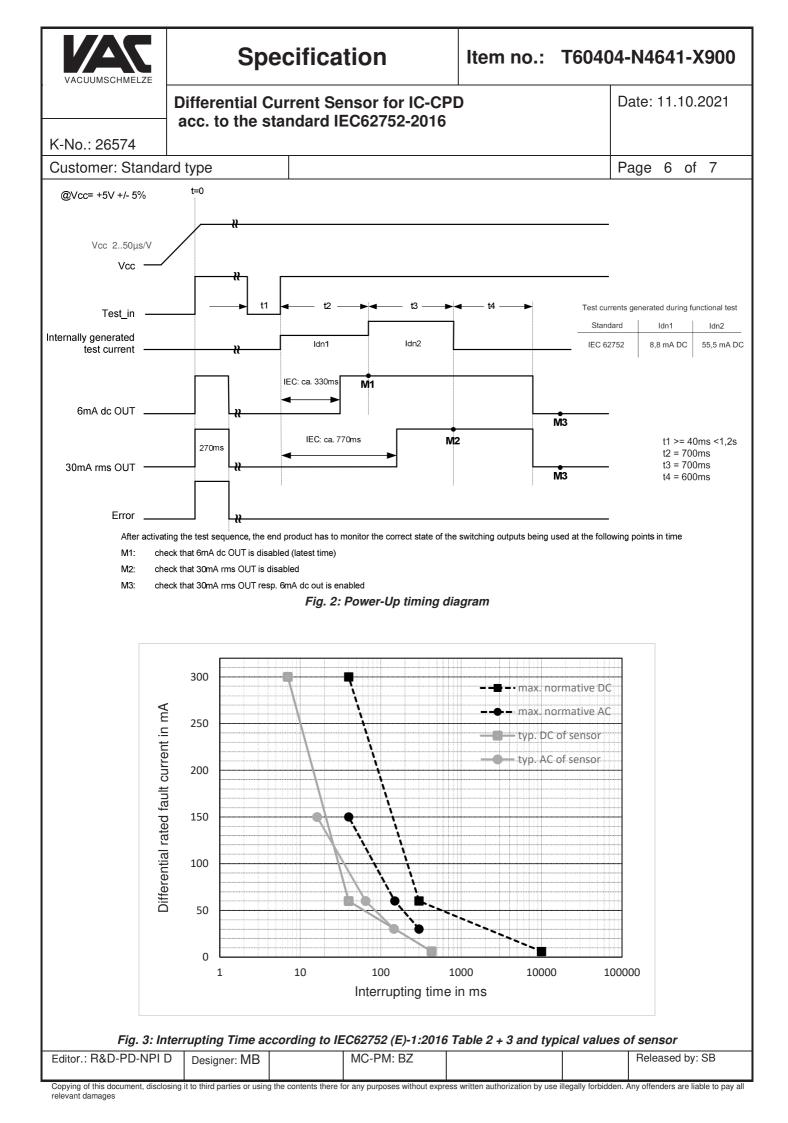
PIN no.	Description						
PIN 1 → ERROR-OUT (open collector output)	If no system fault is detected, the output PIN 1 is a low level (GND). If a system fault is detected, PIN 1 is high impedance. In this case, PINs 3 and 4 will be set to a high impedance state (see tab. 1).						
	A function test including an offset measurement (this value is stored in EEPROM for further calculation) is activated if this PIN is connected to GND for a period of 30ms to 1.2s. If the PIN is set to GND less than 30ms or more than 1.2s, no function test will be performed.						
PIN 2 \rightarrow TEST-IN (refer to Fig. 2)	Attention: During the functional test and offset measurement, no differential current may flow.						
	To ensure high accuracy of the sensor this test should be activated at regular intervals (e.g. at startup, before measuring).						
	If a push-pull switch is used, the voltage range must be 0V5V.						
PIN 3 \rightarrow X6-OUT (open collector output)	If the residual current is below 6mA dc and no system fault occurs the output on PIN 3 is a low level (GND). In any other case output PIN 3 is in a high impedance state. If PIN 4 is high impedance, PIN 3 will also be set to high impedance (see tab. 1).						
PIN 4 \rightarrow X30-OUT (open collector output)	If the residual current is below the 30mA rms and no system fault occurs the output on PIN 4 is a low level (GND). In any other case PINs 3 and 4 is in a high impedance state (see tab. 1).						
PIN 5 → GND	Ground connection						
PIN 6 → VCC	Positive supply voltage						
PIN 7 → PWM-OUT	Acc. to the DC component of residual current a duty-cycle with f=8kHz is generated. This is for monitoring purposes only and is not safety function! Refer to S _{PWM-OUT} = 3.33%/mA						
PIN 8 \rightarrow N.C.	Not connected						
r.: R&D-PD-NPI D Designer: MB	MC-PM: BZ Released by: SE						

VACUUMSCHMELZE	Specificat	tion	Item no.:	T6040 4	-N4641- 2	X900
	Differential Current Ser acc. to the standard IE		D	[Date: 11.10.	.2021
K-No.: 26574						
Customer: Standa	rd type			F	Page 3 of	f 7
Typical applica	tion diagram:	Differential Sensor for IC - CPD	PIN 5 PIN 8 nc.		••• PE	
Absolute maximum	Ratings ⁽⁶⁾ : Collector-Emitter volt	tago (PINs 1, 3 an		Min Typ	. Max 40	Unit V
	Collector current (PI	Ns 1, 3 and 4)	,		50	mA
Vcc	Maximum supply vol Maximum rated volta	U	/	-0.3	7 250	V
U _{MAX}	Maximum rated volta (AC rms)					
VTEST-IN, low VTEST-IN, high	TEST-IN Input Voltag TEST-IN Input Voltag			0 2.5	0.6 5	V
⁽⁵⁾ Stresses above t Exposure to these o	hese ratings may cause permanent conditions for extended periods may n of the device at these or any other	damage. / degrade device relia	ability.		J	·
Editor.: R&D-PD-NPI	D Designer: MB	MC-PM: BZ			Released by	r: SB

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VACUUMSCHMELZE	Specification			Item no.:	T60404-N4641-X900			
	Differential Current Sensor for IC-CPD acc. to the standard IEC62752-2016					.10.2021		
K-No.: 26574								
Customer: Standard type						Page 4	of 7	
Final Tests: (Me	asurements afte	r temperature bala	ance of the samples	at room temperatu	ire, SC=sigi	nificant cha	racteristic)	
					Min.	Max.	Unit	
Vcc		ly voltage			4.9	5.1	V	
		y current			38.0	45.0	mA	
TEST-IN (SC)		-IN voltage			2.8 0	3.3	V	
X6-OUT (normal) X30-OUT (normal)		JT voltage)UT voltage	0	0.6 0.6	V			
ERROR-OUT (normal)		OR-OUT voltage			0	0.6	V	
X6-OUT (activated	,	•	ed @5V, 1kΩ (pull-up)*	r	4.9	5.1	V	
X30-OUT (activated		-	ted @5V, 1kΩ (pull-up)		4.9	5.1	V	
ERROR-OUT	<i>.</i>	-			4.9	5.1	V	
(activated)	ERRO	R-OUT voltage ad	ctivated @5V, 1kΩ (pu	ıll-up)*		0.1		
TC1		urrent 1 – X6			4.5	5.4	mA	
TC2	Trip c	urrent 2 – X6			-5.4	-4.5	mA	
TC3		urrent 3 – X30@50)Hz		20	30	mA	
PWM-OUT (freque	• •	OUT frequency			7.8 18	8.2	kHz	
PWM-OUT (duty-c	• •	PWM-OUT duty-cycle @6mA DC				22	%	
LV1		Limit values of break time - X6-OUT@6mA DC			0	700	ms	
LV3		Limit values of break time - X30-OUT@30mA, 50Hz ctor-emitter voltage and current see "Absolute maximum ratings"			0	300	ms	
Product Tests	Acc.	to VAC sheet M3 wing tests differ f			pass	sed		
		Damp heat, stea 1000-4-1, EN602	ady state. Duration 270, M3024	: 1000 h	1.5		kVrms	
PD	(extir	ction) *acc. to ta						
ESD	U=±2	Air- and contact discharge; U=±2000V, R=1500Ω, C=100pF Acc. to Human Body Model JESD22-A114			±2.0)	kV	
	IEC6 elect 1GH: induc	IEC61000-4-3 (Radiated, radio-frequency, electromagnetic field immunity) 20V/m 80MHz – 1GHz 80%AM 1kHz, recommend with the use of inductance of >220µH in series of Vcc input.			passed			
EMC	distu	IEC61000-4-6 (Immunity to conducted disturbances), recommend with the use of inductance of >220µH in series of Vcc input.						
					Should be			
		IEC61000-6-4 (Emission standard for industrial			done in			
	envir	environments, conducted disturbances)			end application			
	Amp	tude and phase	response over fred					
A(f), Φ(f)		Amplitude and phase response over frequency 1% of I _{PN} or I _{Δn}				passed		
Impulse test	Moni					passed		
Editor.: R&D-PD-NPI I	Editor.: R&D-PD-NPI D Designer: MB MC-PM: BZ Released by: SB							

VACUUMSCHMELZE	Specification			Item no.:	T60404-	N4641-X900
			nsor for IC-CF EC62752-2016	D	Da	ate: 11.10.2021
K-No.: 26574						
Customer: Standa	rd type				Pa	age 5 of 7
Requalification	Tests: (replicated e	every year, Prec	ondition acc. to M3238)		
Ûw, prim-sec M30	64 PIN	1-8 vs. insula	us/50µs waveform ated primary wire ty +, 5 pulse → po		5	.5 kV rms
U _d M30	PIN		ated primary wire	N	1	.5 kV rms
UPDE M30	24 PIN		voltage (extinctior ated primary wire)	1	.2 kV rms
UPD x 1.875 M30	24 PIN *acc.		voltage (extinctior ated primary wire)	1	.5 kV rms
* IEC 61800-5-1:200						
- Vcc durin		test must be	hould not exceed at least 4.8V	105°C.		
low-level (GN	Output conditio for X6-OUT and X30-OU El I _{ΔΝ1} /I _{ΔΝ2} is accou	Fig. 1: Mean mplished the ance. Depen	ding on the existe	High Z covery level 30-OUT will chang nce of the different below recovery thr	ial curent I∆,	the
Editor.: R&D-PD-NPI I	D Designer: MB		MC-PM: BZ			Released by: SB
			pr any purposes without expre			-



VACUUMSCHMELZE	Specification				Item no.: T60404-N4641-X90			
	Differential C acc. to the s) D			Da	Date: 11.10.2021		
K-No.: 26574		I						
Customer: Standard type Page 7 of 7								
1000								
5 100								
₹ 100								
en e								
se							_	
100 / my esbourse value / my 10 / my								
<u>ຍ</u> 10								
					- X30 30mA	rmc		
					- 10 3011	x 11115		
					limits acc.	to IEC62	752	
1								
1		10	equency / Hz	100				1000
		Fig. 4: Response	e value over fi	requenc	:У			
	X6-OUT	X30-OUT	ERROR-C	DUT	St	ate		
	GND	GND	GND		Normal	conditi	on	
	High impedance	GND	GND		I∆n1≥	6mA _{DC}		
	High impedance	High impedance	GND		$I_{\Delta N2} \ge 3$	30mA _{rm}	IS	
	High impedance	High impedance	High impe	dance	Error, sy	stem fa	ault	
		tions not mentione						
	conditions occu	ir, the sensor is an	unknown sta	ate and	describes	an Errc	or.	
Table 1: Possible output states								
Editor.: R&D-PD-NPI	D Designer: MB	MC-P	M: BZ					Released by: SB